

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S17	8	US-20020052065-\$. DID. OR US- 20040150104-\$.DID. OR US-20030185484-\$. DID. OR US- 20040070064-\$.DID.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/03 13:57
S18	1	post adj electrode and interposer and interposer adj base and silicon	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/03 14:07
S19	2	post adj electrode and interposer and interposer adj base	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/03 14:09
S20	8	interposer with silicon and electronic adj element with silicon and electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/09 15:51
S21	5	interposer adj base with silicon	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/09 16:05
S22	621	interposer with silicon and (element chip die) with silicon	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/09 16:08
S23	1	interposer with silicon and (element chip die) with silicon and post adj electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/09 16:08

S24	1	interposer with silicon and (element chip die) with silicon and (post column cylindrical) adj electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/09 16:09
S25	218	interposer with silicon and (element chip die) with silicon and electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/09 16:09
S26	152	interposer with silicon and (element chip die) with silicon and electrode and @ay<"2006"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/09 16:09
S27	78	interposer with silicon and (element chip die) with silicon and electrode and @ay<"2003"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/09 16:10
S28	192	interposer with silicon and ((silicon S) adj element chip die) and electrode and @ay<"2006"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/09 16:14
S29	3	interposer with silicon and ((silicon S) adj element chip die) and electrode and @ay<"2006" and (post columnar cylindrical) adj electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/09 16:18
S30	1	"20020052065"	US-PGPUB; USPAT	OR	OFF	2008/12/09 16:30
S31	12	interposer with direct adj contact with chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/09 17:18

S32	8	US-20020052065-\$. DID. OR US- 20040150104-\$.DID. OR US-20030185484-\$. DID. OR US- 20040070064-\$.DID.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/09 17:26
S34	20	interposer and interposer adj base and @ay<="2003"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/10 15:03
S35	20	interposer adj base and @ay<="2003"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/10 15:05
S38	2	post adj electrode and interposer and interposer adj base	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/10 15:33
S39	44	(columnar post cylindrical) adj electrode and interposer	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/10 15:41
S40	20	(columnar post cylindrical) adj electrode and interposer and @ay<="2003"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/10 15:41
S41	33	(columnar post cylindrical) adj electrode and interposer and @ay<="2005"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/10 15:41
S42	58	interposer and interposer adj base	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/10 16:55

S43	58	interposer with interposer adj base	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/10 16:55
S44	2	interposer with base with (post cylindrical columnar) adj electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/10 17:32
S45	5	(interposer interposer adj substrate) with (post cylindrical columnar) adj electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/10 17:33
S46	5	interposer with interposer adj base with silicon	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/12/10 18:30

12/ 24/ 2008 1:40:27 PM

C:\Documents and Settings\tgreen1\My Documents\EAST\Workspaces\10577017.wsp